LN1871Y5TR

Surface Mounting Chip LED

S-GW Type

Absolute Maximum Ratings $T_a = 25^{\circ}C$

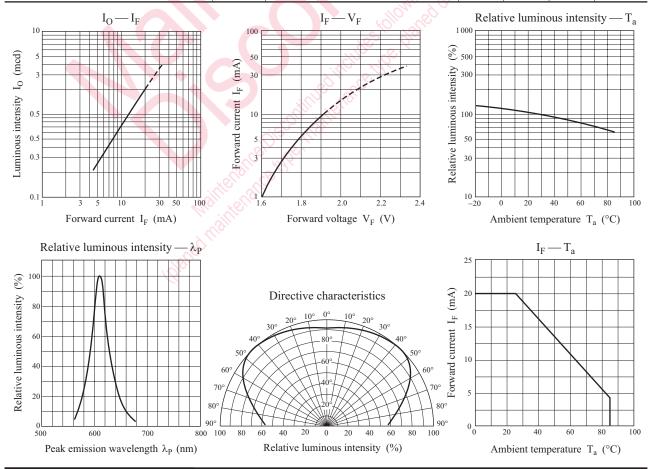
Parameter	Symbol	Rating	Unit	
Power dissipation	P _D	60	mW	
Forward current	I _F	20	mA	
Pulse forward current *	I _{FP}	60	mA	
Reverse voltage	V _R	3	V	
Operating ambient temperature	T _{opr}	-25 to +85	°C	
Storage temperature	T _{stg}	-30 to +100	°C	

Lighting Color

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

Electro-Optical Characteristics $T_a = 25^{\circ}C$

I d					X.	0-1111	
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity	Io	$I_F = 10 \text{ mA}$		0.3	0.8	2	mcd
Reverse current	I _R	$V_R = 3 V$			1000	10	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$		(00, cc)	1.93	2.6	V
Peak emission wavelength	λ_P	$I_F = 10 \text{ mA}$	illes and	din	610		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	in Oni	<i>.</i>	40		nm

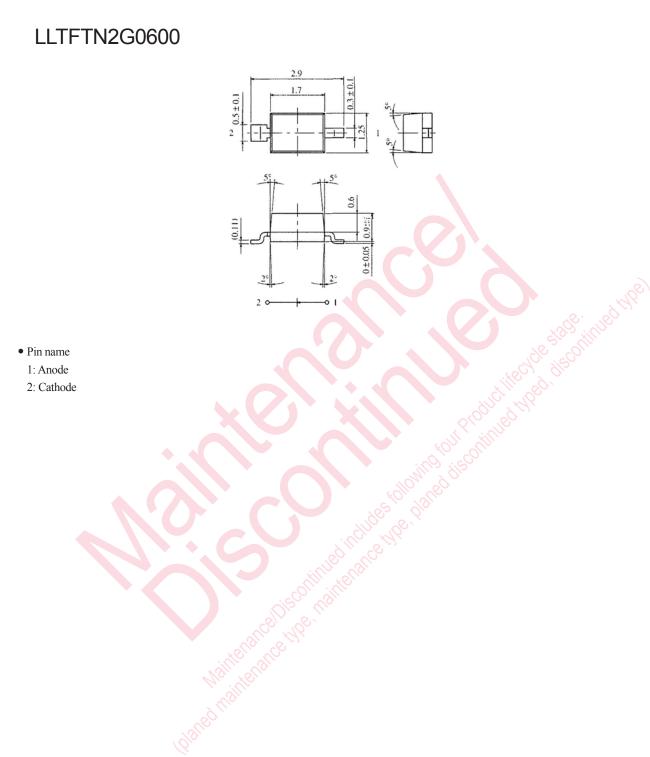


[•] Soft Orange

LN1871Y5TR

Panasonic

Package (Unit: mm)



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